DB2J313

Silicon epitaxial planar type

For small current rectification

Features

- \bullet Low forward voltage $V_{\rm F}$ and small reverse current $I_{\rm R}$
- Low terminal capacitance C_t
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

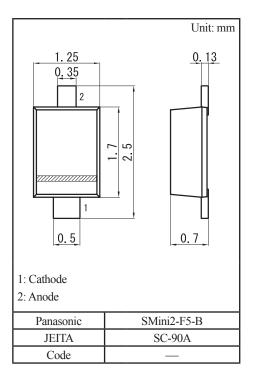
Marking Symbol: BD

Packaging

DB2J31300L Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

Parameter	Symbol	Rating	Unit				
Reverse voltage	V _R	30	V				
Repetitive peak reverse voltage	V _{RRM}	30	V				
Forward current (Average)	I _{F(AV)}	200	mA				
Peak forward current	I _{FM}	300	mA				
Non-repetitive peak forward surge current *	I _{FSM}	1	А				
Junction temperature	Tj	125	°C				
Storage temperature	T _{stg}	-55 to +125	°C				





Note) *: 50 Hz sine wave 1 cycle (Non-repetitive peak current)

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

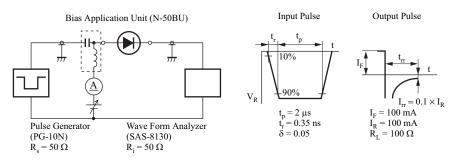
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _F	$I_{\rm F} = 200 {\rm mA}$			0.55	V
Reverse current	I _R	$V_R = 30 V$			50	μΑ
Terminal capacitance	Ct	$V_{R} = 10 V, f = 1 MHz$		3.8		pF
Reverse recovery time *	t _{rr}	$\begin{split} I_F = I_R = 100 \text{ mA}, \ I_{rr} = 0.1 \times I_R \ , \\ R_L = 100 \ \Omega \end{split}$		1.5		ns

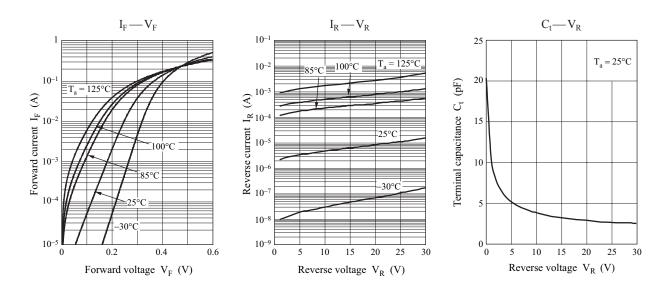
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

3. Absolute frequency of input and output is 1 GHz

*: trr measurement circuit

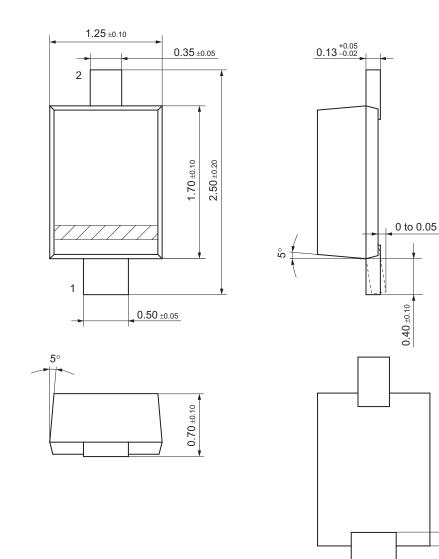




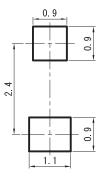
SMini2-F5-B

Unit: mm

(0.15)



Land Pattern (Reference) (Unit: mm)



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